# FAIRCHILD

SEMICONDUCTOR

# FSAM15SM60A Motion SPM<sup>®</sup> 2 Series

# Features

- UL Certified No. E209204
- 600 V 15 A 3 Phase IGBT Inverter Bridge Including Control ICs for Gate Driving and Protection
- Three Separate Open Emitter Pins from Low Side IGBTs for Three Leg Current Sensing
- Single-Grounded Power Supply Thanks to Built-in HVIC
- Typical Switching Frequency of 5 kHz
- Built-in Thermistor for Temperature Monitoring
- Inverter Power Rating of 0.8 kW / 100~253 VAC
- Isolation Rating of 2500 Vrms / min.
- Low Thermal Resistance by Using Ceramic Substrate
- Adjustable Current Protection Level by Changing the Value of Series Resistor Connected to the Emitters of Sense-IGBTs

# Applications

• Motion Control - Home Appliance / Industrial Motor

#### September 2013

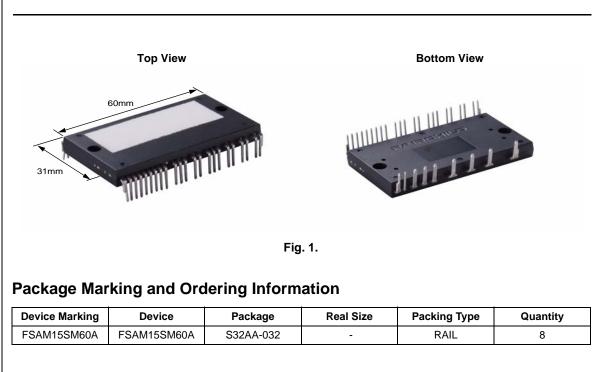
# FSAM15SM60A Motion SPM® 2

Series

**General Description** FSAM15SM60A Is A Motion SPM® 2 Series that Fairchild Has Developed to Provide A Very Compact and Low Cost, yet High Performance Inverter Solution for AC Motor Drives in Low-Power Applications Such as Air Conditioners. It Combines Optimized Circuit Protections and Drive Matched to Low-Loss IGBTs. Effective Over-Current Protection Is Realized Through Advanced Current Sensing IGBTs. The System Reliability Is Further Enhanced by The Built-in Thermistor and Integrated Under-Voltage Lock-Out Protection. In Addition The Incorporated HVIC Facilitates The Use of Single-Supply Voltage Without Any Negative Bias. Inverter Leg Current Sensing Can Be Implemented Because of Three Separate Nagative DC Terminals.

# **Related Source**

• AN-9043 : Motion SPM® 2 Series User's Guide



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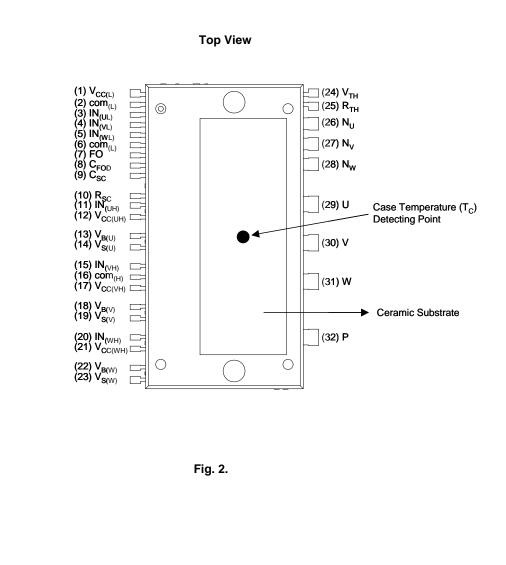
# **Integrated Power Functions**

• 600 V - 15 A IGBT inverter for 3-phase DC / AC power conversion (Please refer to Fig. 3)

# Integrated Drive, Protection and System Control Functions

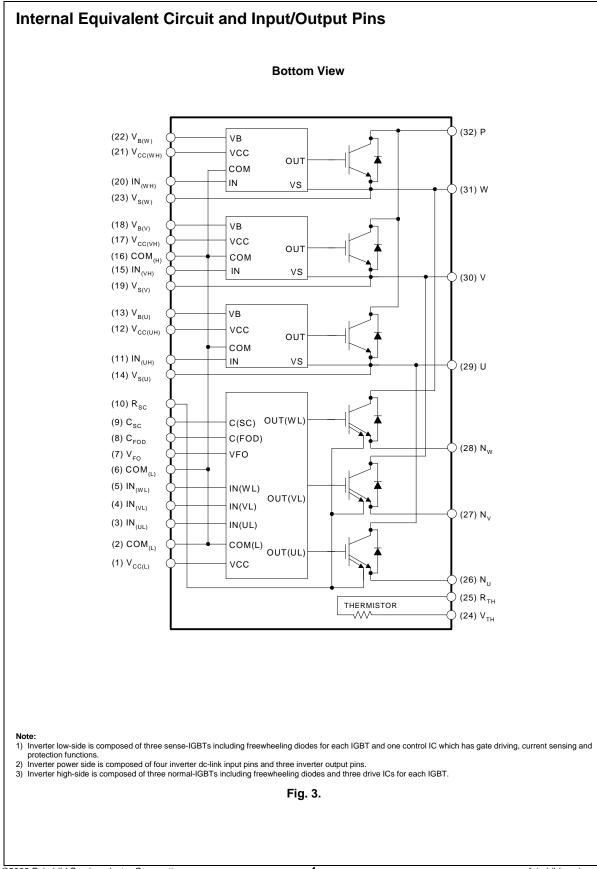
- For inverter high-side IGBTs: Gate drive circuit, High voltage isolated high-speed level shifting
  - Control circuit under-voltage (UV) protection
  - Note) Available bootstrap circuit example is given in Figs. 14 and 15.
- For inverter low-side IGBTs: Gate drive circuit, Short-Circuit (SC) protection
  - Control supply circuit under-voltage (UV) protection
- Temperature Monitoring: System over-temperature monitoring using built-in thermistor
- Note) Available temperature monitoring circuit is given in Fig. 15.
  Fault signaling: Corresponding to a SC fault (Low-side IGBTs) or a UV fault (Low-side control supply circuit)
- Input interface: Active-low interface, can work with 3.3 / 5 V Logic

# **Pin Configuration**



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n Number	Pin Name	Pin Description
1	V <sub>CC(L)</sub>	Low-side Common Bias Voltage for IC and IGBTs Driving
2	COM <sub>(L)</sub>	Low-side Common Supply Ground
3	IN <sub>(UL)</sub>	Signal Input for Low-side U Phase
4	IN <sub>(VL)</sub>	Signal Input for Low-side V Phase
5	IN <sub>(WL)</sub>	Signal Input for Low-side W Phase
6	COM <sub>(L)</sub>	Low-side Common Supply Ground
7	V <sub>FO</sub>	Fault Output
8	C <sub>FOD</sub>	Capacitor for Fault Output Duration Time Selection
9	C <sub>SC</sub>	Capacitor (Low-pass Filter) for Short-Circuit Current Detection Input
10	R <sub>SC</sub>	Resistor for Short-Circuit Current Detection
11	IN <sub>(UH)</sub>	Signal Input for High-side U Phase
12	V <sub>CC(UH)</sub>	High-side Bias Voltage for U Phase IC
13	V <sub>B(U)</sub>	High-side Bias Voltage for U Phase IGBT Driving
14	V <sub>S(U)</sub>	High-side Bias Voltage Ground for U Phase IGBT Driving
15	IN <sub>(VH)</sub>	Signal Input for High-side V Phase
16	COM(H)	High-side Common Supply Ground
17	V <sub>CC(VH)</sub>	High-side Bias Voltage for V Phase IC
18	V <sub>B(V)</sub>	High-side Bias Voltage for V Phase IGBT Driving
19	V <sub>S(V)</sub>	High-side Bias Voltage Ground for V Phase IGBT Driving
20	IN <sub>(WH)</sub>	Signal Input for High-side W Phase
21	V <sub>CC(WH)</sub>	High-side Bias Voltage for W Phase IC
22	V <sub>B(W)</sub>	High-side Bias Voltage for W Phase IGBT Driving
23	V <sub>S(W)</sub>	High-side Bias Voltage Ground for W Phase IGBT Driving
24	V <sub>TH</sub>	Thermistor Bias Voltage
25	R <sub>TH</sub>	Series Resistor for the Use of Thermistor (Temperature Detection)
26	NU	Negative DC-Link Input for U Phase
27	N <sub>V</sub>	Negative DC-Link Input for V Phase
28	N <sub>W</sub>	Negative DC-Link Input for W Phase
29	U	Output for U Phase
30	V	Output for V Phase
31	W	Output for W Phase
32	Р	Positive DC-Link Input



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# Absolute Maximum Ratings ( $T_J = 25^{\circ}C$ , Unless Otherwise Specified)

#### **Inverter Part**

Item	Symbol	Condition	Rating	Unit
Supply Voltage	V <sub>PN</sub>	Applied between P- $N_U$ , $N_V$ , $N_W$	450	V
Supply Voltage (Surge)	V <sub>PN(Surge)</sub>	Applied between P- NU, NV, NW	500	V
Collector-Emitter Voltage	V <sub>CES</sub>		600	V
Each IGBT Collector Current	± I <sub>C</sub>	$T_{\rm C} = 25^{\circ}{\rm C}$	15	A
Each IGBT Collector Current	± I <sub>C</sub>	$T_{\rm C} = 100^{\circ}{\rm C}$	12	A
Each IGBT Collector Current (Peak)	± I <sub>CP</sub>	T <sub>C</sub> = 25°C , Instantaneous Value (Pulse)	30	A
Collector Dissipation	P <sub>C</sub>	T <sub>C</sub> = 25°C per One Chip	50	W
Operating Junction Temperature	T,	(Note 1)	-20 ~ 125	°C

Note: 1. It would be recommended that the average junction temperature should be limited to  $T_J \le 125^{\circ}C$  (@ $T_C \le 100^{\circ}C$ ) in order to guarantee safe operation.

#### **Control Part**

ltem	Symbol	Condition	Rating	Unit
Control Supply Voltage	V <sub>CC</sub>	Applied between $V_{CC(UH)}$ , $V_{CC(VH)}$ , $V_{CC(WH)}$ - $COM_{(H)}$ , $V_{CC(L)}$ - $COM_{(L)}$	20	V
High-side Control Bias Voltage	V <sub>BS</sub>	Applied between $V_{B(U)}$ - $V_{S(U)}$ , $V_{B(V)}$ - $V_{S(V)}$ , $V_{B(W)}$ - $V_{S(W)}$	20	V
Input Signal Voltage	V <sub>IN</sub>	$ \begin{array}{l} \mbox{Applied between IN}_{(UH)}, \mbox{IN}_{(VH)}, \mbox{IN}_{(WH)} \mbox{-} \mbox{COM}_{(H)} \\ \mbox{IN}_{(UL)}, \mbox{IN}_{(VL)}, \mbox{IN}_{(WL)} \mbox{-} \mbox{COM}_{(L)} \end{array} $	-0.3 ~ V <sub>CC</sub> +0.3	V
Fault Output Supply Voltage	V <sub>FO</sub>	Applied between V <sub>FO</sub> - COM <sub>(L)</sub>	-0.3 ~ V <sub>CC</sub> +0.3	V
Fault Output Current	I <sub>FO</sub>	Sink Current at V <sub>FO</sub> Pin	5	mA
Current Sensing Input Voltage	V <sub>SC</sub>	Applied between C <sub>SC</sub> - COM <sub>(L)</sub>	-0.3 ~ V <sub>CC</sub> +0.3	V

# **Total System**

Item	Symbol	Condition	Rating	Unit
Self Protection Supply Voltage Limit (Short-Circuit Protection Capability)	V <sub>PN(PROT)</sub>	$V_{CC} = V_{BS} = 13.5 \sim 16.5 \text{ V}$ T <sub>J</sub> = 125°C, Non-repetitive, less than 6 µs	400	V
Module Case Operation Temperature	T <sub>C</sub>	Note Fig.2	-20 ~ 100	°C
Storage Temperature	T <sub>STG</sub>		-20 ~ 125	°C
Isolation Voltage	V <sub>ISO</sub>	60 Hz, Sinusoidal, AC 1 minute, Connection Pins to Heat-sink Plate	2500	V <sub>rms</sub>

# **Absolute Maximum Ratings**

# **Thermal Resistance**

ltem	Symbol	Condition	Min.	Тур.	Max.	Unit
Junction to Case Thermal Resistance	R <sub>th(j-c)Q</sub>	Each IGBT under Inverter Operating Condition	-	-	2.5	°C/W
	R <sub>th(j-c)F</sub>	Each FWDi under Inverter Operating Condition	-	-	3.6	°C/W
Contact Thermal Resistance	R <sub>th(c-h)</sub>	Ceramic Substrate (per 1 Module) Thermal Grease Applied (Note 3)	-	-	0.06	°C/W

Note: 2. For the measurement point of case temperature( $T_C$ ), please refer to Fig. 2. 3. The thickness of thermal grease should not be more than 100um.

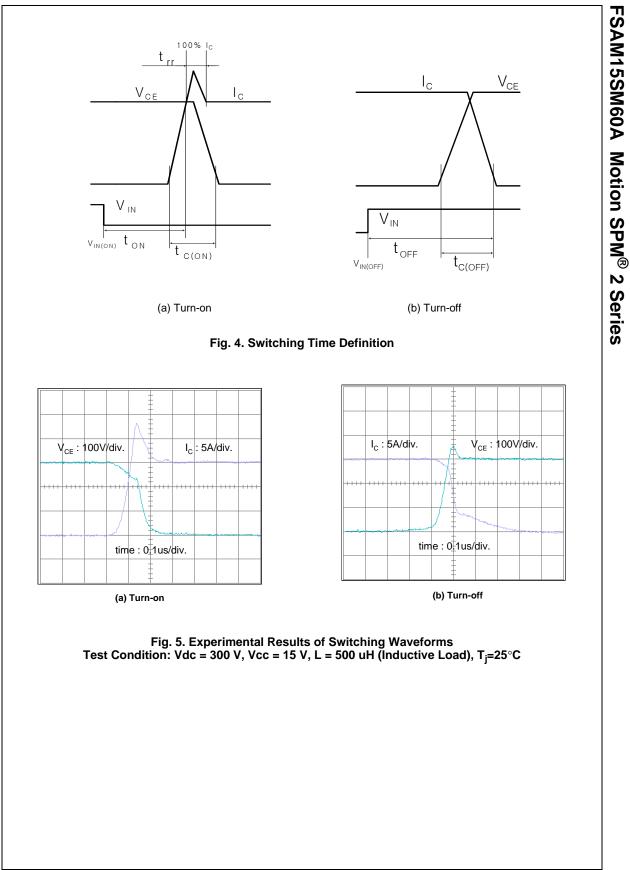
# Electrical Characteristics (T<sub>J</sub> = 25°C, Unless Otherwise Specified)

# **Inverter Part**

Item	Symbol	Condition			Тур.	Max.	Unit
Collector - Emitter	V <sub>CE(SAT)</sub>	$V_{CC} = V_{BS} = 15 V$ $V_{IN} = 0 V$	I <sub>C</sub> = 15 A, T <sub>J</sub> = 25°C	-	-	2.3	V
Saturation Voltage		$V_{IN} = 0 V$	I <sub>C</sub> = 15 A, T <sub>J</sub> = 125°C	-	-	2.4	V
FWDi Forward Voltage	V <sub>FM</sub>	V <sub>IN</sub> = 5 V	I <sub>C</sub> = 15 A, T <sub>J</sub> = 25°C	-	-	2.5	V
			I <sub>C</sub> = 15 A, T <sub>J</sub> = 125°C	-	-	2.3	V
Switching Times	t <sub>ON</sub>	V <sub>PN</sub> = 300 V, V <sub>CC</sub> = V <sub>BS</sub> = 15 V		-	0.32	-	us
	t <sub>C(ON)</sub>	$I_C = 15 \text{ A}, T_J = 25^{\circ}\text{C}$ $V_{IN} = 5 \text{ V} \leftrightarrow 0 \text{ V}, \text{ Inductive Load}$ (High, Low-side)	-	0.15	-	us	
	t <sub>OFF</sub>		-	0.83	-	us	
	t <sub>C(OFF)</sub>	(high, Low-side)		-	0.39	-	us
	t <sub>rr</sub>	(Note 4)		-	0.13	-	us
Collector - Emitter Leakage Current	I <sub>CES</sub>	$V_{CE} = V_{CES}, T_J = 25^{\circ}C$		-	-	250	μΑ

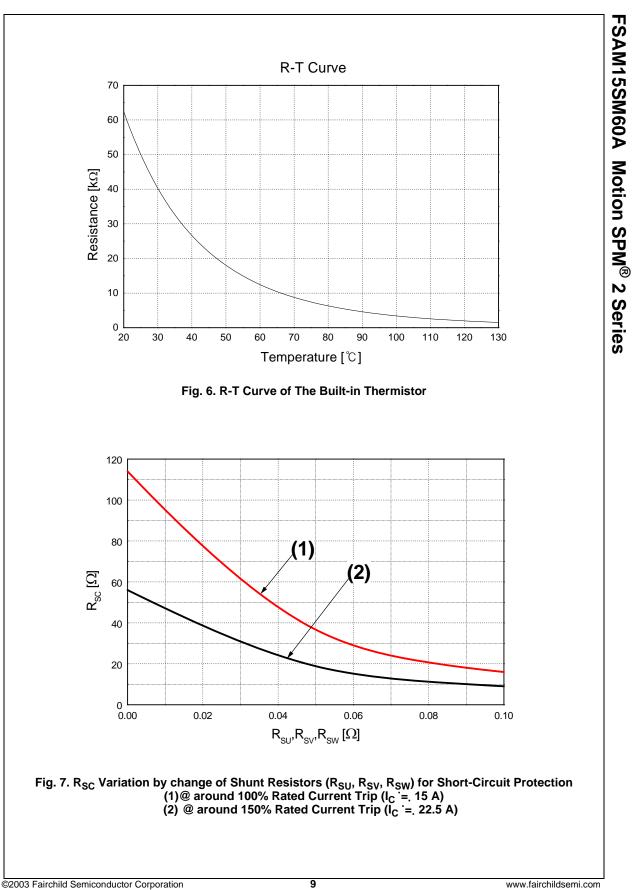
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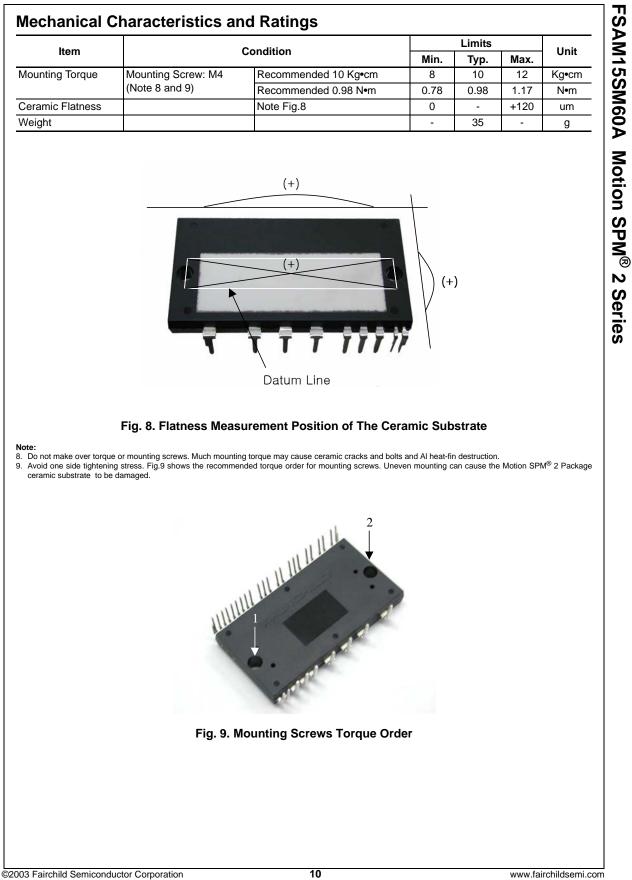
t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay time of the internal drive IC. t<sub>C(ON)</sub> and t<sub>C(OFF)</sub> are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Fig. 4.



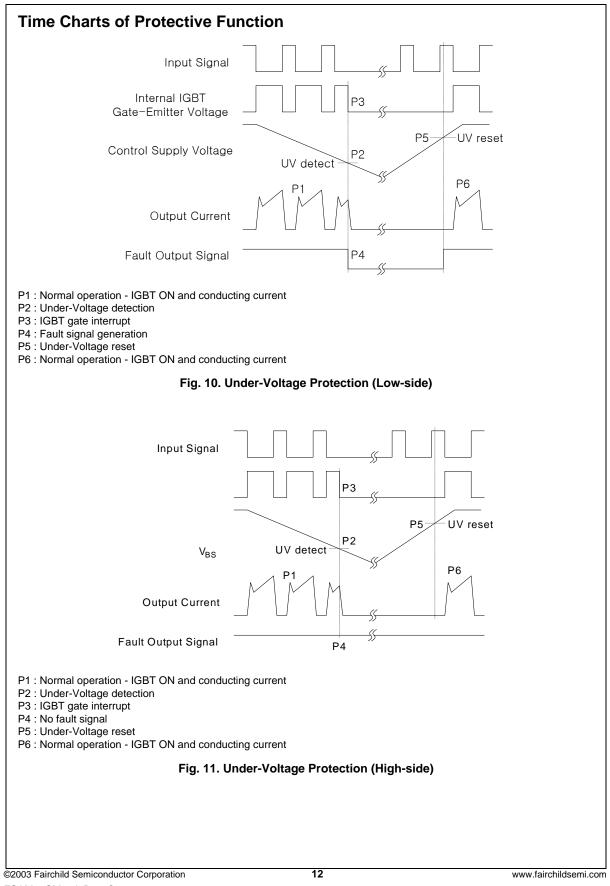
Control Part							
Item	Symbol		Condition	Min.	Тур.	Max.	Unit
Control Supply Voltage	V <sub>CC</sub>	Applied between		13.5	15	16.5	V
		V <sub>CC(UH)</sub> , V <sub>CC(VH)</sub> , V <sub>CC(WH)</sub> , V <sub>CC(L)</sub> - COM					
High-side Bias Voltage	$V_{BS}$	Applied between V <sub>B(U)</sub> - V <sub>S(U)</sub> , V <sub>B(V)</sub> - V <sub>S(V)</sub> , V <sub>B(W)</sub> - V <sub>S(W)</sub>		13.5	15	16.5	V
Quiescent V <sub>CC</sub> Supply Current	I <sub>QCCL</sub>	$V_{CC} = 15 V$ $IN_{(UL, VL, WL)} = 5 V$	V <sub>CC(L)</sub> - COM <sub>(L)</sub>	-	-	26	mA
	I <sub>QCCH</sub>	V <sub>CC</sub> = 15 V IN <sub>(UH, VH, WH)</sub> = 5 V	V <sub>CC(UH)</sub> , V <sub>CC(VH)</sub> , V <sub>CC(WH)</sub> - COM <sub>(H)</sub>	-	-	130	uA
Quiescent $V_{BS}$ Supply Current	I <sub>QBS</sub>	V <sub>BS</sub> = 15 V IN <sub>(UH, VH, WH)</sub> = 5 V	$V_{B(U)} - V_{S(U)}, V_{B(V)} - V_{S(V)},$	-	-	420	uA
Fault Output Voltage	V <sub>FOH</sub>	V <sub>SC</sub> = 0 V, V <sub>FO</sub> Circui	t: 4.7 kΩ to 5 V Pull-up	4.5	-	-	V
	V <sub>FOL</sub>	V <sub>SC</sub> = 1 V, V <sub>FO</sub> Circui	t: 4.7 kΩ to 5 V Pull-up	-	-	1.1	V
PWM Input Frequency	f <sub>PWM</sub>	$T_C \le 100^{\circ}C, T_J \le 125$	C	-	5	-	kHz
Allowable Input Signal Blanking Time considering Leg Arm-short	t <sub>dead</sub>	$-20^{\circ}C \le T_C \le 100^{\circ}C$			-	-	us
Short-Circuit Trip Level	V <sub>SC(ref)</sub>	V <sub>CC</sub> = 15 V (Note 5)			0.51	0.56	V
Sensing Voltage of IGBT Current	V <sub>SEN</sub>	$T_{C} = 25$ °C, @ $R_{SC} = 56 \Omega$ , $R_{SU} = R_{SV} = R_{SW} = 0 \Omega$ and $I_{C} = 22.5$ A (Note Fig. 7)			0.51	0.56	V
Supply Circuit Under-	UV <sub>CCD</sub>	Detection Level		11.5	12	12.5	V
Voltage Protection	UV <sub>CCR</sub>	Reset Level		12	12.5	13	V
	UV <sub>BSD</sub>	Detection Level		7.3	9.0	10.8	V
	UV <sub>BSR</sub>	Reset Level		8.6	10.3	12	V
Fault Output Pulse Width	t <sub>FOD</sub>	C <sub>FOD</sub> = 33 nF (Note 6)		1.4	1.8	2.0	ms
ON Threshold Voltage	V <sub>IN(ON)</sub>	High-Side	Applied between IN <sub>(UH)</sub> , IN <sub>(VH)</sub> ,	-	-	0.8	V
OFF Threshold Voltage	V <sub>IN(OFF)</sub>		IN <sub>(WH)</sub> - COM <sub>(H)</sub>	3.0	-	-	V
ON Threshold Voltage	V <sub>IN(ON)</sub>	Low-Side	Applied between IN <sub>(UL)</sub> , IN <sub>(VL)</sub> ,	-	-	0.8	V
OFF Threshold Voltage	V <sub>IN(OFF)</sub>		IN <sub>(WL)</sub> - COM <sub>(L)</sub>	3.0	-	-	V
Resistance of Thermistor	R <sub>TH</sub>	@ T <sub>TH</sub> = 25°C (Note	Fig. 6)	-	50	-	kΩ
		@ T <sub>TH</sub> = 100°C (Note	e Fig. 6)	-	3.4	-	kΩ

**Note:** 5. Short-circuit current protection is functioning only at the low-sides. It would be recommended that the value of the external sensing resistor ( $R_{SC}$ ) should be selected around 56  $\Omega$  in order to make the SC trip-level of about 22.5 A at the shunt resistors ( $R_{SU}, R_{SV}, R_{SW}$ ) of 0  $\Omega$ . For the detailed information about the relationship between the external sensing resistor ( $R_{SC}$ ) and the shunt resistors ( $R_{SU}, R_{SV}, R_{SW}$ ), please see Fig. 7. 6. The fault-out pulse width t<sub>FOD</sub> depends on the capacitance value of C<sub>FOD</sub> according to the following approximate equation : C<sub>FOD</sub> = 18.3 x 10<sup>-6</sup> x t<sub>FOD</sub>[F] 7. T<sub>TH</sub> is the temperature of thermistor



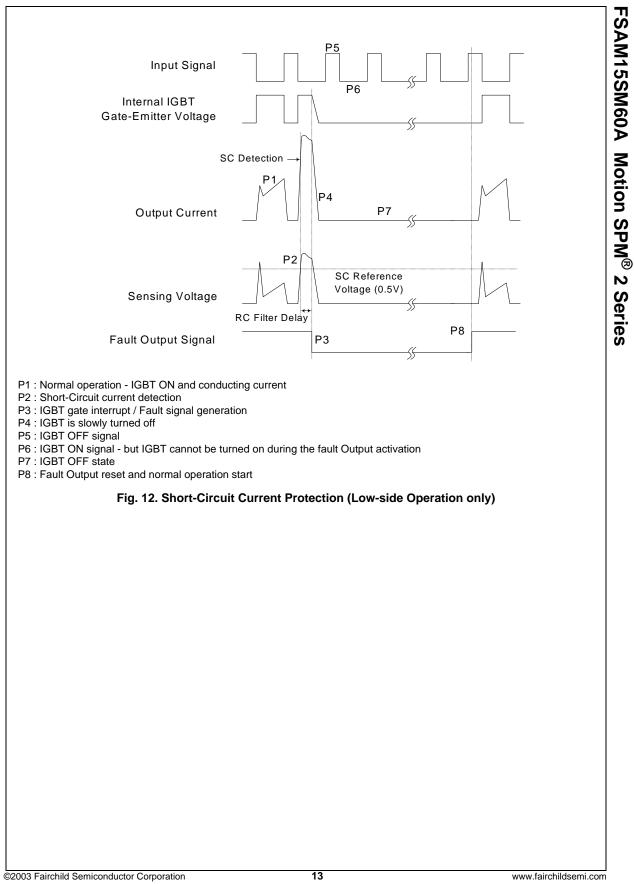


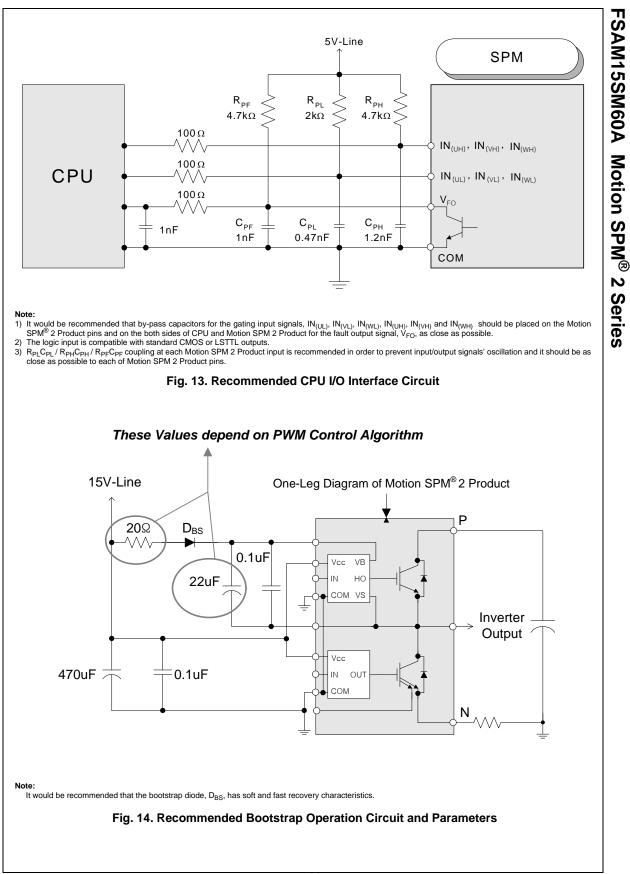
ltom	Symbol	Condition	Value			11
ltem	Symbol		Min.	Тур.	Max.	Unit
Supply Voltage	V <sub>PN</sub>	Applied between P - N <sub>U</sub> , N <sub>V</sub> , N <sub>W</sub>	-	300	400	V
Control Supply Voltage	V <sub>CC</sub>	Applied between $V_{CC(UH)}$ , $V_{CC(VH)}$ , $V_{CC(WH)}$ - COM <sub>(H)</sub> , $V_{CC(L)}$ - COM <sub>(L)</sub>	13.5	15	16.5	V
High-side Bias Voltage	V <sub>BS</sub>	Applied between $V_{B(U)}$ - $V_{S(U)}$ , $V_{B(V)}$ - $V_{S(V)}$ , $V_{B(W)}$ - $V_{S(W)}$	13.5	15	16.5	V
Blanking Time for Preventing Arm-short	t <sub>dead</sub>	For Each Input Signal	3	-	-	us
PWM Input Signal	f <sub>PWM</sub>	$T_C \le 100^{\circ}C, T_J \le 125^{\circ}C$	-	5	-	kHz
Input ON Threshold Voltage	V <sub>IN(ON)</sub>	Applied between $IN_{(UH)}$ , $IN_{(VH)}$ , $IN_{(WH)}$ - $COM_{(H)}$		0 ~ 0.6	5	V
Input OFF Threshold Voltage	V <sub>IN(OFF)</sub>	Applied between IN(UL), IN(VL), IN(WL) - COM(L)		4~5.5		V



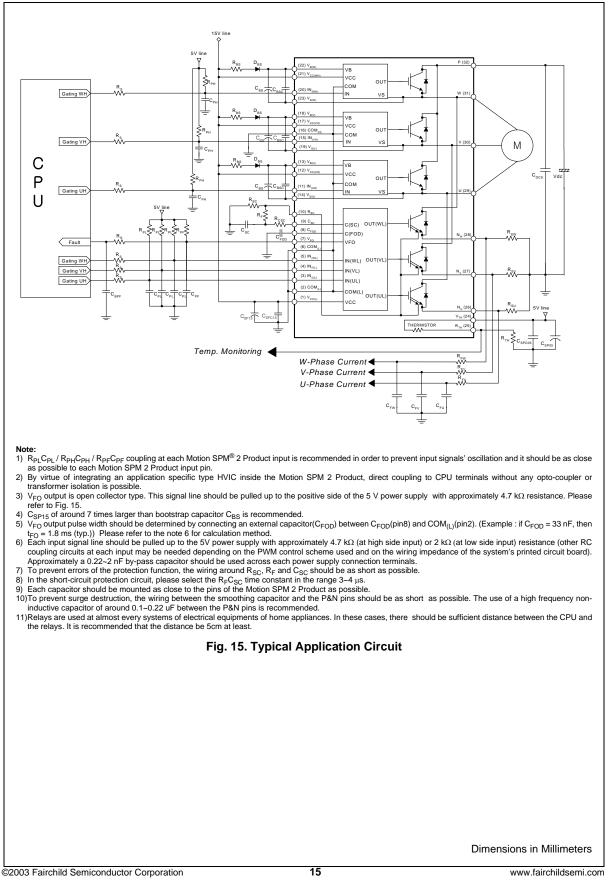
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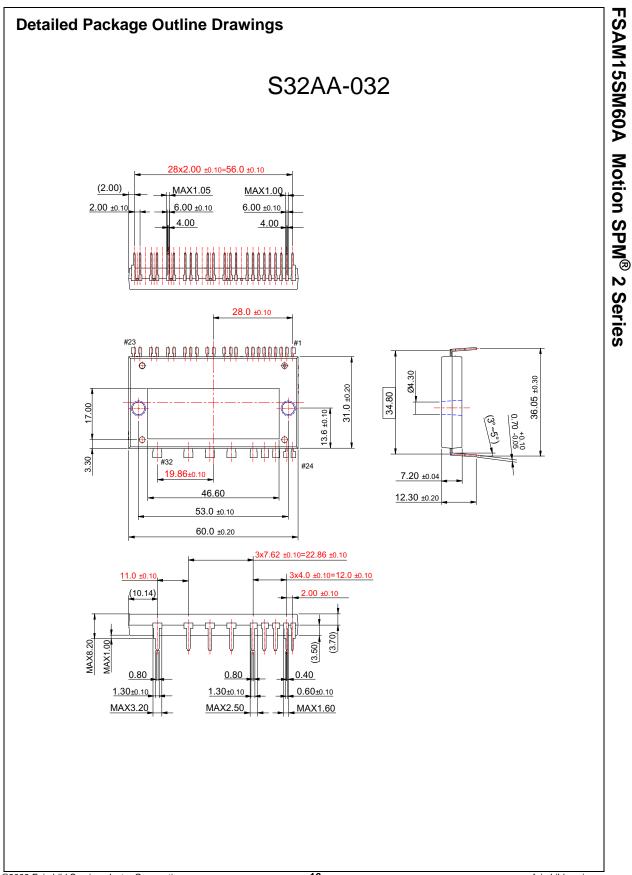




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Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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